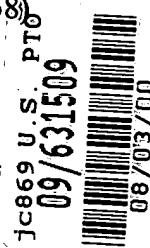




08-04-00

Attorney Docket

B-64909 (013377/0058)



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Box **PATENT APPLICATION**

Assistant Commissioner

for Patents

Washington, D.C. 20231

Sir:

Transmitted herewith for filing is the patent application of:

Inventors: Clyde Maxwell Guest, et al.

For: SYSTEM AND METHOD FOR INSPECTING BUMPED WAFERS

Enclosed are:

<u>1</u> pages of abstract	<u>X</u>	Combined Declaration/
<u>21</u> pages of specification		Power of Attorney
<u>5</u> pages of claims	<u>X</u>	Assignment & Recordation Page
<u>6</u> pages of informal drawings	<u>X</u>	Other: Check & Post Card Receipt
<u>X</u>		Post Office Express Mail Certificate No. EL 524304376 US

The filing fee has been calculated as shown below:

For:	No. Filed	No. Extra	Rate	Large Entity Fee
Basic Fee				\$690.00
Total Claims 20 - 20 =		-0-	x \$ 18.	0.00
Indep. Claims 3 - 3 =		-0-	x \$ 78.	0.00
Multiple dependent claims -none-			+ \$260.	0.00
TOTAL				\$690.00

Our check in the amount of \$690.00 in payment of the filing fee is enclosed.

The Commissioner of Patents and Trademarks is hereby authorized to charge any fee deficiency or to credit any fee overpayment relating to this matter to Deposit Account No. 01-0657. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

Date: August 3, 2000

Christopher J. Rourke  
Attorney for Applicant  
Registration No. 39, 348


AKIN, GUMP, STRAUSS, HAUER & FELD, L.L.P.  
P.O. Box 688  
Dallas, TX 75313-0688  
Phone: 214/969-2800

**BOX PATENT APPLICATION**  
Assistant Commissioner for  
Patents  
Washington, D. C. 20231

**EXPRESS MAIL CERTIFICATE OF  
MAILING UNDER 37 C.F.R. 1.10**

"Express Mail" Mailing Label No. **EL524304376US**  
Date of Deposit: **August 3, 2000**

I hereby certify that the papers enclosed herein are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 C.F.R. 1.10 on the date indicated above and addressed to **BOX PATENT APPLICATION, Assistant Commissioner of Patents, Washington, D.C. 20231.**

  
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Signature

**August 3, 2000**  
\_\_\_\_\_  
Date of Signature

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